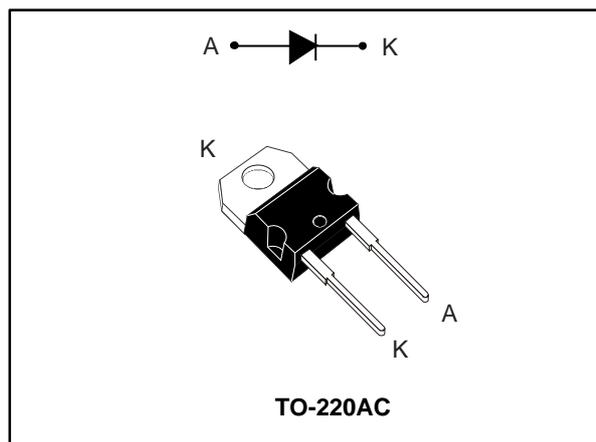


1200 V power Schottky silicon carbide diode

Datasheet - production data



Features

- No or negligible reverse recovery
- Switching behavior independent of temperature
- Robust high voltage periphery

Description

The SiC diode, available in TO-220AC, is an ultrahigh performance power Schottky rectifier. It is manufactured using a silicon carbide substrate. The wide band-gap material allows the design of a low V_F Schottky diode structure with a 1200 V rating. Due to the Schottky construction, no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature. Especially suited for use in PFC and secondary side applications, this ST SiC diode will boost the performance in hard switching conditions. This rectifier will enhance the performance of the targeted application. Its high forward surge capability ensures a good robustness during transient phases.

Table 1: Device summary

Symbol	Value
$I_{F(AV)}$	10 A
V_{RRM}	1200 V
$T_j (max)$	175 °C
$V_F (typ)$	1.35 V

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter		Value	Unit	
V _{RRM}	Repetitive peak reverse voltage (T _j = -40 °C to +175 °C)		1200	V	
I _{F(RMS)}	Forward rms current		25	A	
I _{F(AV)}	Average forward current	T _C = 155 °C, DC current	10	A	
I _{FRM}	Repetitive peak forward current	T _C = 155 °C, T _j = 175 °C, δ = 0.1	38	A	
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	T _C = 25 °C	71	A
			T _C = 150 °C	60	
		t _p = 10 μs square	T _C = 25 °C	420	
T _{stg}	Storage temperature range		-65 to + 175	°C	
T _j	Operating junction temperature range		-40 to + 175	°C	

Table 3: Thermal parameters

Symbol	Parameter	Typ.	Max.	Unit
R _{th(j-c)}	Junction to case	0.65	0.9	°C/W

Table 4: Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-	5	60	μA
		T _j = 150 °C		-	30	400	
V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 10 A	-	1.35	1.50	V
		T _j = 150 °C		-	1.75	2.25	

Notes:

(1)Pulse test: t_p = 10 ms, δ < 2%

(2)Pulse test: t_p = 500 μs, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 1.03 \times I_{F(AV)} + 0.122 I_{F(RMS)}^2$$

Table 5: Dynamic electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Q _{Cj} ⁽¹⁾	Total capacitive charge	V _R =800 V	-	57	-	nC
C _j	Total capacitance	V _R = 0 V, T _c = 25 °C, F = 1 MHz	-	725	-	pF
		V _R = 300 V, T _c = 25 °C, F = 1 MHz	-	60	-	

Notes:

(1)Most accurate value for the capacitive charge: $Q_{cj} = \int_0^{V_{OUT}} C_j(V_R) \cdot dV_R$

1.1 Characteristics (curves)

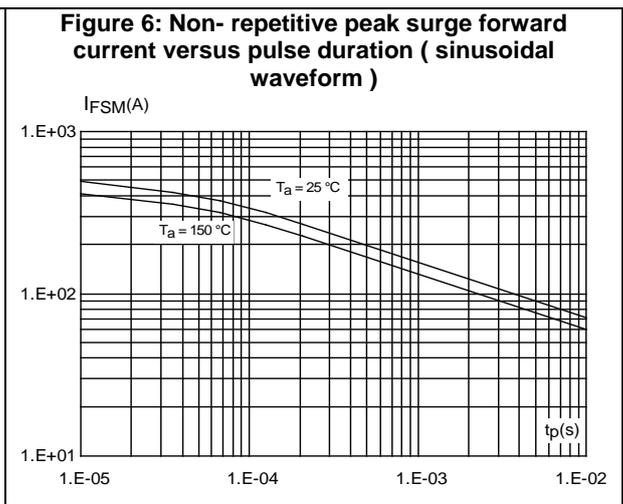
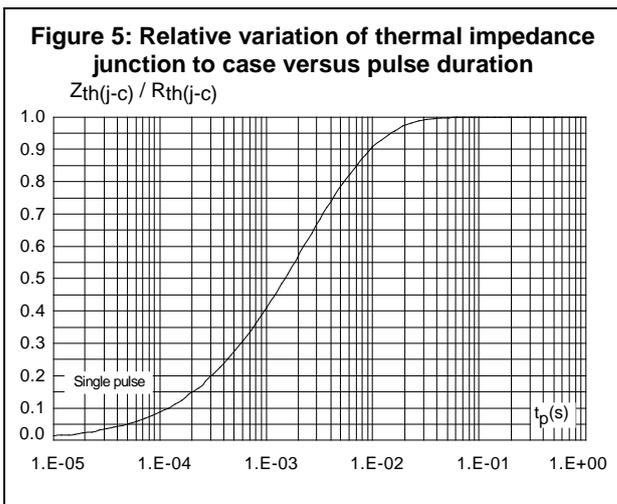
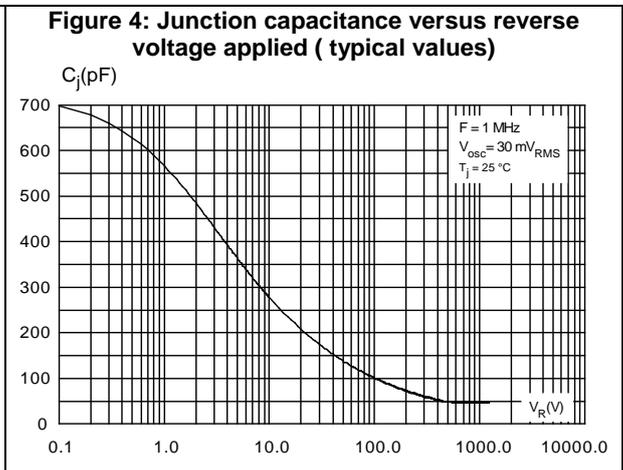
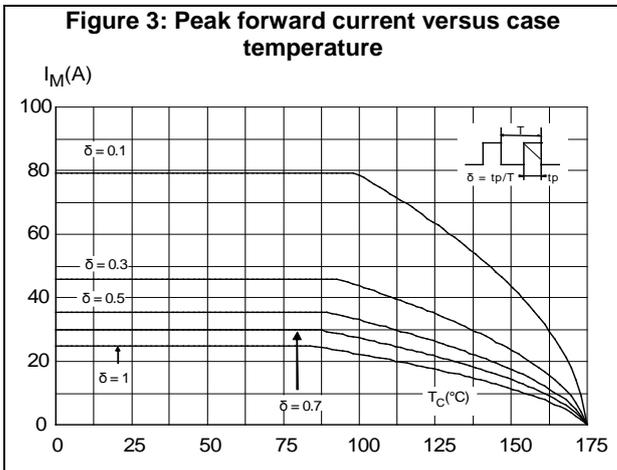
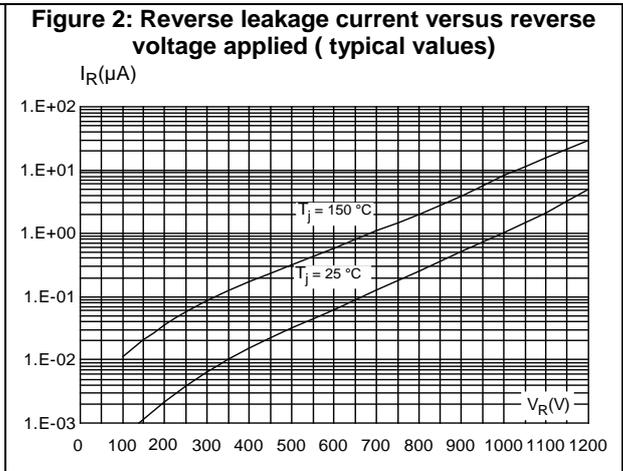
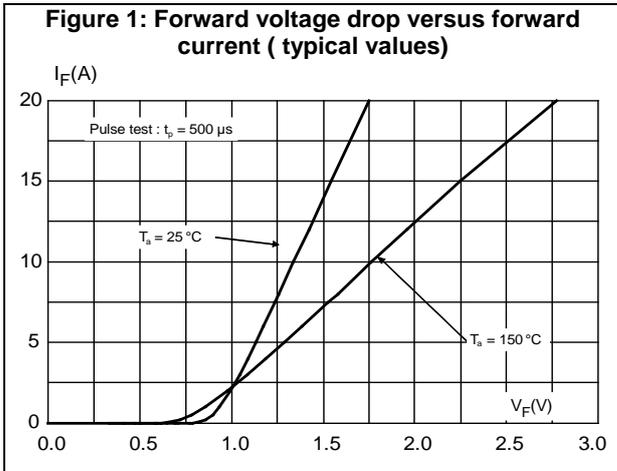


Figure 7: Total capacitive charges versus reverse voltage applied (typical values)

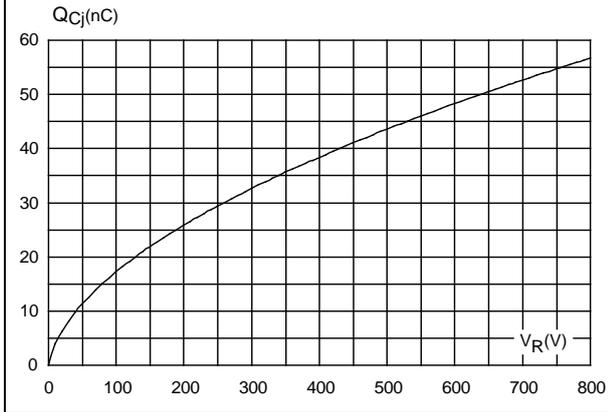


Table 6: TO-220AC package mechanical data

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
H2	10.00	10.40	0.393	0.409
L2	16.40 typ.		0.645 typ.	
L4	13.00	14.00	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam	3.75	3.85	0.147	0.151

3 Ordering information

Table 7: Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPSC10H12D	STPSC10H12D	TO-220AC	1.86 g	50	Tube

4 Revision history

Table 8: Document revision history

Date	Revision	Changes
03-May-2016	1	First issue

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